

b) about 30 weight percent to about 60 weight percent of a terpene phenolic tackifier; and

c) about 15 weight percent to about 55 weight percent of a wax with a melting point of about 125°F to 180°F;

wherein the hot melt composition can be applied at a temperature of 200°F to 300°F.

Claim 8. A hot melt adhesive composition comprising, by weight of the hot melt adhesive composition,

a) about 35 weight percent of an ethylene-vinyl acetate copolymer with about 40 weight percent vinyl acetate and having a melt index of at about 1,000;

b) about 30 weight percent of a terpene phenolic tackifier;

c) about 5 weight percent of at least one additional tackifier selected from the group consisting of pentaerythritol, hydrogenated glycerol, and combinations thereof;

d) about 30 weight percent of a wax with a melting point of about 150°F;

wherein the hot melt composition can be applied at a temperature of 200°F to 300°F.

Claim 11. An adhesive according to Claim 1 which comprises about 35 weight percent to about 45 weight percent of an ethylene-vinyl acetate copolymer.